

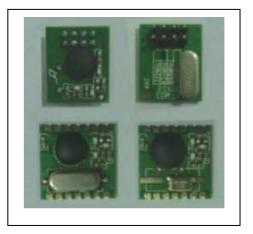
# RFM02 Universal ISM Band FSK Transmitter

## DESCRIPTION

Hope's RFM02 is a single chip, low power, multi-channel FSK transmitter designed for use in applications requiring FCC or ETSI conformance for unlicensed use in the 433, 868, and 915 MHz bands. Used in conjunction with RF01, Hope's FSK receiver, the RFM02 transmitter produces a flexible, low cost, and highly integrated solution that does not require production alignments. All required RF functions are integrated. Only an external crystal and bypass filtering are needed for operation. The RFM02 offering a higher output power and an improved phase noise characteristic.

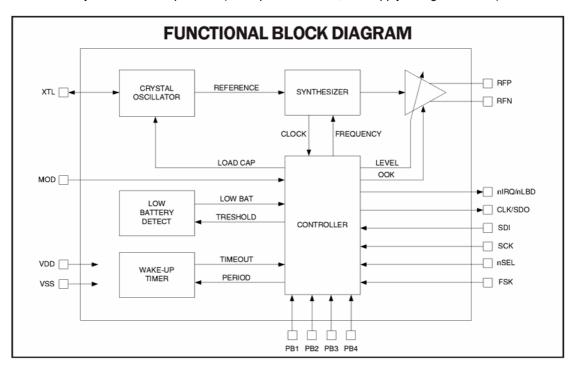
The RFM02 features a completely integrated PLL for easy

## RFM02



RF design, and its rapid settling time allows for fast frequency hopping, bypassing multipath fading and interference to achieve robust wireless links. In addition, highly stable and accurate FSK modulation is accomplished by direct closed-loop modulation with bit rates up to 115.2 kbps. The PLL's high resolution allows the use of multiple channels in any of the bands.

The integrated power amplifier of the transmitter has an open-collector differential output that directly drive a loop antenna with programmable output level. No additional matching network is required. An automatic antenna tuning circuit is built in to avoid costly trimming procedures and de-tuning due to the "hand effect".



For low-power applications, the device supports automatic activation from sleep mode. Active mode can be initiated by several wake-up events (on-chip timer timeout, low supply voltage detection).



## **FEATURES**

- Fully integrated (low BOM, easy design-in)
- No alignment required in production
- Fast settling, programmable, high-resolution PLL
- Fast frequency hopping capability
- Stable and accurate FSK modulation with programmable deviation
- Programmable PLL loop bandwidth
- Direct loop antenna drive
- Automatic antenna tuning circuit
- Programmable output power level
- SPI bus for applications with microcontroller
- Clock output for microcontroller
- Integrated programmable crystal load capacitor
- Multiple event handling options for wake-up activation
- Wake-up timer
- Low battery detection
- 2.2V to 5.4V supply voltage
- Low power consumption
- Low standby current (0.3 μA)
- Transmit bit synchronization

# **TYPICAL APPLICATIONS**

- Remote control
- Home security and alarm
- Wireless keyboard/mouse and other PC peripherals
- Toy control
- Remote keyless entry
- Tire pressure monitoring
- Telemetry
- Personal/patient data logging
- Remote automatic meter reading

# **DETAILED FEATURE-LEVEL DESCRIPTION**

The RFM02 FSK transmitter is designed to cover the unlicensed frequency bands at 433, 868, and 915 MHz. The device facilitates compliance with FCC and ETSI requirements.

#### PLL

The programmable PLL synthesizer determines the operating frequency, while preserving accuracy based on the on-chip crystal-controlled reference oscillator. The PLL's high resolution allows the usage of multiple channels in any of the bands. The FSK deviation is selectable (from 30 to 210 kHz with 30 kHz increments) to accommodate various bandwidth, data rate and crystal tolerance requirements, and it is also highly accurate due to the direct closed-loop modulation of the PLL. The transmitted digital data can be sent asynchronously through the FSK pin or over the control interface using the appropriate command.

### **RF Power Amplifier (PA)**

The power amplifier has an open-collector differential output and can directly drive a loop antenna with a programmable output power level. An automatic antenna tuning circuit is built in to avoid costly trimming procedures and the so-called "hand effect."





#### **Crystal Oscillator**

The chip has a single-pin crystal oscillator circuit, which provides a 10 MHz reference signal for the PLL. To reduce external parts and simplify design, the crystal load capacitor is internal and programmable. Guidelines for selecting the appropriate crystal can be found later in this datasheet.

The transmitters can supply the clock signal for the microcontroller, so accurate timing is possible without the need for a second crystal. When the chip receives a Sleep Command from the microcontroller and turns itself off, it provides several further clock pulses ("clock tail") for the microcontroller to be able to go to idle or sleep mode. The length of the clock tail is programmable.

#### Low Battery Voltage Detector

The low battery voltage detector circuit monitors the supply voltage and generates an interrupt if it falls below a programmable threshold level.

#### Wake-Up Timer

The wake-up timer has very low current consumption (1.5 uA typical) and can be programmed from 1 ms to several days with an accuracy of  $\pm 5\%$ .

It calibrates itself to the crystal oscillator at every startup, and then every 30 seconds. When the oscillator is switched off, the calibration circuit switches on the crystal oscillator only long enough for a quick calibration (a few milliseconds) to facilitate accurate wake-up timing.

#### **Event Handling**

In order to minimize current consumption, the device supports sleep mode. Active mode can be initiated by several wake-up events: timeout of wake-up timer, detection of low supply voltage or through the serial interface.

If any wake-up event occurs, the wake-up logic generates an interrupt, which can be used to wake

up the microcontroller, effectively reducing the period the microcontroller has to be active. The cause of the interrupt can be read out from the transmitters by the microcontroller through the nIRQ pin.

#### Interface

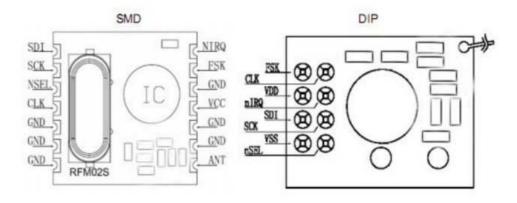
An SPI compatible serial interface lets the user select the operating frequency band and center frequency of the synthesizer, polarity and deviation of FSK modulation, and output power level. Division ratio for the microcontroller clock, wake-up timer period, and low battery detector threshold are also programmable. Any of these auxiliary functions can be disabled when not needed. All parameters are set to default after power-on; the programmed values are retained during sleep mode.



RFM02

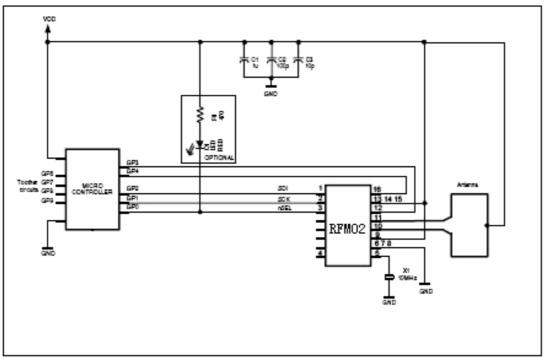
# PACKAGE PIN DEFINITIONS

Pin type key: D=digital, A=analog, S=supply, I=input, O=output, IO=input/output



Definition	TYPE	function
FSK	DI	FSK data input
CLK	DO	clock out for MCU (1 MHz-10 MHz)
VDD	S	Positive power supply
nIRQ	DO	Interrupts request output (active low)
SDI	DI	SPI data input
SCK	DI	SPI clock input
VSS	S	negative power supply, GND
nSEL	DI	Chip select (active low)

# **Typical application**





# **GENERAL DEVICE SPECIFICATION**

All voltages are referenced to  $V_{\text{ss}},$  the potential on the ground reference pin VSS.

Symbol	Parameter	Min	Max	Units
V <sub>dd</sub>	Positive supply voltage	-0.5	6.0	V
Vin	Voltage on any pin except open collector outputs	-0.5	V <sub>dd</sub> +0.5	V
V <sub>oc</sub>	Voltage on open collector outputs	-0.5	6.0	V
l <sub>in</sub>	Input current into any pin except VDD and VSS	-25	25	mA
ESD	Electrostatic discharge with human body model		1000	V
T <sub>st</sub>	Storage temperature	-55	125	°C

#### Absolute Maximum Ratings (non-operating)

#### Recommended Operating Range

Symbol	Parameter	Min	Max	Units
$V_{dd}$	Positive supply voltage	2.2	5.4	V
V <sub>oc</sub>	Voltage on open collector outputs (Max 6.0 V)	V <sub>dd</sub> - 1	V <sub>dd</sub> + 1	V
T <sub>op</sub>	Ambient operating temperature	-40	85	°C

# **ELECTRICAL SPECIFICATION**

(Min/max values are valid over the whole recommended operating range, typ conditions:

T<sub>op</sub> =27°C;V<sub>dd</sub> =V<sub>oc</sub>=2.7V)

### **DC** Characteristics

Symbol	Parameter		Conditions/Notes	Min	Тур	Max	Units
I <sub>dd_TX_0</sub>	Supply current	433 MHz band	Active state with		12		mA
	(TX mode,	868 MHz band	0dBm		14		
	Pout =0dBm)	915 MHz band	output power		15		
$I_{dd\_TX\_PMAX}$	Supply current	433 MHz band	Active state with		21		mA
	(TX mode,	868 MHz band	maximum output		23		
	Pout =P <sub>max</sub> )	915 MHz band	power		24		
I <sub>pd</sub>	Standby current	in sleep mode	All blocks		0.3		μA
	(Note 1)		disabled				
l <sub>wt</sub>	Wake-up timer c	urrent			1.5		μA
	consumption						
I <sub>Ib</sub>	Low battery dete	ector current			0.5		μA
	consumption						
I <sub>x</sub>	Idle current		Only crystal		1.5		mA
			oscillator is on				



V <sub>Iba</sub>	Low battery detection accuracy			+/-3		%
V <sub>lb</sub>	Low battery detector threshold	Programmable in	2.2		5.3	V
		0.1 V steps				
V <sub>il</sub>	Digital input low level				$0.3^{*}V_{dd}$	V
V <sub>ih</sub>	Digital input high level		$0.7^{*}V_{dd}$			V
lil	Digital input current	$V_{il} = 0 V$	-1		1	μA
l <sub>ih</sub>	Digital input current	$V_{ih}=V_{dd},V_{dd}=5.4$	-1		1	μA
		V				
V <sub>ol</sub>	Digital output low level	$I_{ol} = 2 \text{ mA}$			0.4	V
V <sub>oh</sub>	Digital output high level	I <sub>oh</sub> = -2 mA	V <sub>dd</sub> -0.4			V

## **AC Characteristic**

Symbol	Parameter	Conditions/Notes	Min	Тур	Max	Units
f <sub>ref</sub>	PLL reference frequency	Crystal operation mode is parallel (Note 2)	9	10	11	MHz
		433MHz band, 2.5kHz resolution	430.24		439.75	
f <sub>o</sub>		868MHz band, 5.0kHz resolution 915MHz band, 7.5kHz	860.48 900.72		879.51 929.27	MHz
		resolution				
t <sub>lock</sub>	PLL lock time	Frequency error < 10 kHz after 10 MHz step, POR default PLL setting(Note 7)		20		μs
t <sub>sp</sub>	PLL startup time	After turning on from idle mode, with crystal oscillator already stable, POR default PLL setting (Note 7)			250	μs
Ι <sub>ουτ</sub>	Open collector output current (Note 3)	At all bands	0.5		6	mA
P <sub>maxL</sub>	Available output power (433MHz band)	With opt. antenna impedance (Note 4)		8		dBm
P <sub>maxH</sub>	Available output power (868 and 915 MHz band)	With opt. antenna impedance (Note 4)		6		dBm
P <sub>out</sub>	Typical output power	Selectable in 3 dB steps (Note 3)	P <sub>max</sub> -21		P <sub>max</sub>	dBm
P <sub>sp</sub>	Spurious emission	At max power with loop antenna (Note 5)			-50	dBc



1	orrionio					
	Output capacitance	At low bands	1.5	2.3	2.8	
Co	(set by the automatic	At high bands	1.6	2.2	3.1	pF
	antenna tuning circuit)					
Qo	Quality factor of the		16	18	22	pF
Q	output capacitance					Pi
Lout	Output phase noise	100 kHz from carrier		-85		dBc/Hz
∟out	Output phase hoise	1 MHz from carrier (Note 7)		-105		ubc/Hz
BR <sub>FSK</sub>	FSK bit rate	(Note 7)			115.2	kbps
-14	FSK frequency	Drogrammable in 20 kl la store	30		210	
$df_{fsk}$	deviation	Programmable in 30 kHz steps				kHz
	Crystal load	Programmable in 0.5 pF steps,	8.5		16	
C <sub>xl</sub>	capacitance See	tolerance +/-10%				pF
Uxl	Crystal Selection					рг
	Guidelines					
t	Internal POR timeout	After $V_{\text{dd}}$ has reached 90% of			50	ms
t <sub>POR</sub>	(Note 6)	final value				1115
+	Crystal oscillator	Cructal ESP < 100 Ohma		1.5	5	<b>m</b> 0
t <sub>sx</sub>	startup time	Crystal ESR < 100 Ohms				ms
	Wake-up timer clock	Colibrated evens 20 eccande	0.95		1.05	
t <sub>PBt</sub>	period	Calibrated every 30 seconds				ms
	Programmable		1		5 *10 <sup>11</sup>	
t <sub>wake-up</sub>	wake-up time					ms
	Digital input				2	
$C_{\text{in, D}}$	capacitance					pF
	Digital output rise/fall	45 a 5 avra and a itina la sh			10	
t <sub>r, f</sub>	time	15 pF pure capacitive load				ns

**Note 1:** Using a CR2032 battery (225 mAh capacity), the expected battery life is greater than 2 years using a 60-second wake-up period for sending 50 byte packets in length at 19.2 kbps with +6 dBm output power in the 915 MHz band.

Note 2: Using anything but a 10 MHz crystal is allowed but not recommended because all

crystal-referred timing and frequency parameters will change accordingly.

Note 3: Adjustable in 8 steps.

Note 4: Optimal antenna admittance/impedance for the RFM02:

	Yantenna [S]	Zantenna [Ohm]	Lantenna [nH]
434 MHz	1.3E-3 - j6.3E-3	31 + j152	58.00
868 MHz	1.35E-3 - j1.2E-2	9 + j82	15.20
915 MHz	1.45E-3 - j1.3E-2	8.7 + j77	13.60

Note 5: With selective resonant antennas .

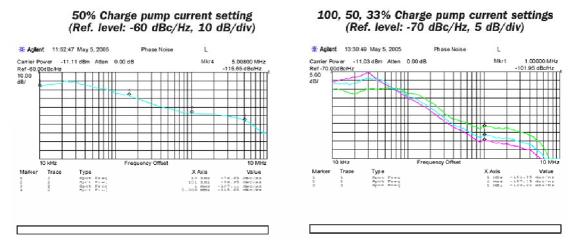
Note 6: During this period, no commands are accepted by the chip.

**Note 7:** The maximum FSK bitrate and the Output phase noise are dependent on the actual setting of the PLL Setting Command.



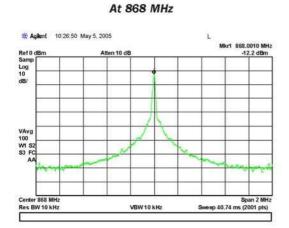
# **TYPICAL PERFORMANCE DATA (RFM02)**

#### Phase noise measurements in the 868 MHz ISM band

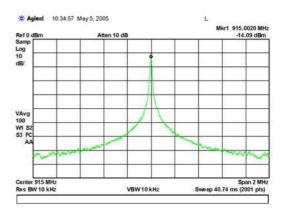


#### **Unmodulated RF Spectrum**

The output spectrum is measured at different frequencies. The output is loaded with 50 Ohms through a matching network.

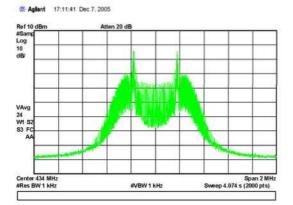


#### At 915 MHz

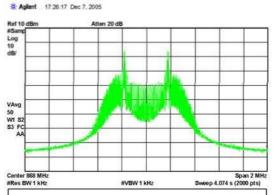


#### Modulated RF Spectrum

At 433 MHz with 180 kHz Deviation at 9.6 kbps

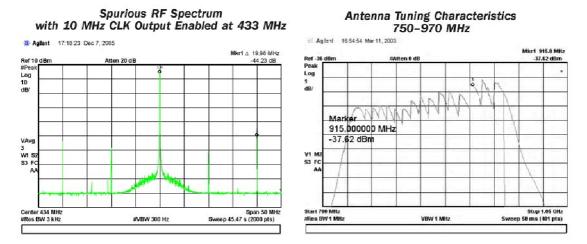


#### At 868 MHz with 180 kHz Deviation at 9.6 kbps





#### **Other Important Characteristics**



The antenna tuning characteristics was recorded in "max-hold" state of the spectrum analyzer. During the measurement, the transmitters were forced to change frequencies by forcing an external reference signal to the XTL pin. While the carrier was changing the antenna tuning circuit switched trough all the available states of the tuning circuit. The graph clearly demonstrates that while the complete output circuit had about a 40 MHz bandwidth, the tuning allows operating in a 220 MHz band. In other words the tuning circuit can compensate for 25% variation in the resonant frequency due to any process or manufacturing spread.

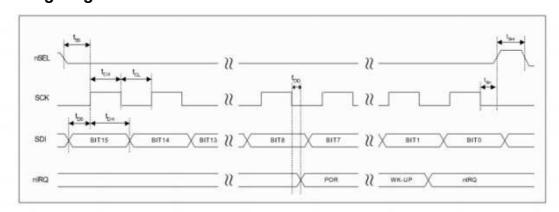
## **CONTROL INTERFACE**

Commands to the transmitters are sent serially. Data bits on pin SDI are shifted into the device upon the rising edge of the clock on pin SCK whenever the chip select pin nSEL is low. When the nSEL signal is high, it initializes the serial interface. The number of bits sent is an integer multiple of 8. All commands consist of a command code, followed by a varying number of parameter or data bits. All data are sent MSB first (e.g. bit 15 for a 16-bit command). Bits having no influence (don't care) are indicated with X. The Power On Reset (POR) circuit sets default values in all control and command registers.

## Timing Specification

Symbol	Parameter	Minimum Value [ns]
t <sub>CH</sub>	Clock high time	25
t <sub>CL</sub>	Clock low time	25
t <sub>SS</sub>	Select setup time (nSEL falling edge to SCK rising edge)	10
t <sub>SH</sub>	Select hold time (SCK falling edge to nSEL rising edge)	10
t <sub>SHI</sub>	Select high time	25
t <sub>DS</sub>	Data setup time (SDI transition to SCK rising edge)	5
t <sub>DH</sub>	Data hold time (SCK rising edge to SDI transition)	5
t <sub>OD</sub>	Data delay time	10





## **Control Commands**

	Control Command	Related Parameters/Functions
1	Configuration Setting Command	Frequency band, microcontroller clock output, crystal load
1	Configuration Setting Command	capacitance, frequency deviation
2	Power Management Command	Crystal oscillator, synthesizer, power amplifier, low battery
2	Power Management Command	detector, wake-up timer, clock output buffer
3	Frequency Setting Command	Carrier frequency
4	Data Rate Command	Bit rate
5	Power Setting Command	Nominal output power, OOK mode
6	Low Battery Detector Command	Low battery threshold limit
7	Sleep Command	Length of the clock tail after power down
8	Wake-Up Timer Command	Wake-up time period
9	Data Transmit Command	Data transmission
10	Status Register Command	Transmitter status read
11	PLL Setting Command	PLL bandwidth can be modified by this command

**Note:** In the following tables the POR column shows the default values of the command registers after power-on.

#### 1. Configuration Setting Command

				•													
bit	15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0	POR
	1	0	0	b1	b0	d2	d1	d0	x3	x2	x1	x0	ms	m2	m1	m0	8080h

b1	b0	Frequency Band [MHz]
0	1	433
1	0	868
1	1	915

x3	x2	x1	x0	Crystal Load Capacitance [pF]
0	0	0	0	8.5
0	0	0	1	9.0
0	0	1	0	9.5
		1	1	16.0
	•			
1	1	1	0	15.5



-		.0		
d2	d1	d0	Clock Output	
			Frequency [MHz]	
0	0	0	1	
0	0	1	1.25	
0	1	0	1.66	
0	1	1	2	
1	0	0	2.5	
1	0	1	3.33	
1	1	0	5	
1	1	1	10	

The resulting output frequency can be calculated as:  $f_{out} = f0 - (-1)^{SIGN} * (M + 1) * (30 \text{ kHz})$ where: f0 is the channel center frequency (see the next command) M is the three bit binary number <m2 : m0> SIGN = (ms) XOR (FSK input) Note:

• Use M in a range from 0 to 6.

#### 2. Power Management Command

bit	15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0	POR
	1	1	0	0	0	0	0	0	a1	a0	ex	es	ea	eb	et	dc	C000h

Bits 5-0, enable the corresponding block of the transmitters, i.e. the crystal oscillator is enabled by the ex bit, the synthesizer by es, the power amplifier by ea and the low battery detector by eb, while the wake-up timer by et. The bit dc disables the clock output buffer.

When receiving the Data Transmit Command, the chip supports automatic on/off control over the crystal oscillator, the PLL and the PA.

If bit a1 is set, the crystal oscillator and the synthesizer are controlled automatically. Data Transmit Command starts up the crystal oscillator and as soon as a stable reference frequency is available the synthesizer starts. After a subsequent delay to allow locking of the PLL, if a0 is set the power amplifier is turned on as well.

#### Note:

To enable the automatic internal control of the crystal oscillator, the synthesizer and the power amplifier, the corresponding bits (ex, es, ea) must be zero in the Power Management Command.

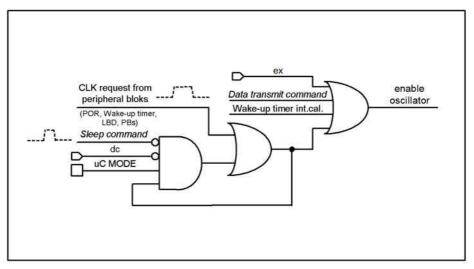
The ex bit should be set in the Power Management Command for the correct control of es and ea. The oscillator can be switched off by clearing the ex bit after the transmission.

The Sleep Command can be used to indicate the end of the data transmission process.

For processing the events caused by the peripheral blocks (POR, LBD or wake-up timer) the chip requires operation of the crystal oscillator. This operation is fully controlled internally, independently from the status of the ex bit, but if the dc bit is zero, the oscillator remains active until Sleep Command is issued. (This command can be considered as an event controller reset.)



### **Oscillator control logic**



#### 3. Frequency Setting Command

bit	15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0	POR
	1	0	1	0	f11	f10	f9	f8	f7	f6	f5	f4	f3	f2	f1	f0	A7D0h

The 12-bit parameter of the Frequency Setting Command <f11 : f0> has the value F. The value F should be in the range of 96 and 3903. When F is out of range, the previous value is kept. The synthesizer center frequency  $f_0$  can be calculated as:

 $f_0 = 10 \text{ MHz} * C1 * (C2 + F/4000)$ 

The constants C1 and C2 are determined by the selected band as:

Band [MHz]	C1	C2
433	1	43
868	2	43
915	3	30

#### Note:

• For correct operation of the frequency synthesizer, the frequency and band of operation need to be programmed before the synthesizer is started. Directly after activation of the synthesizer, the RF VCO is calibrated to ensure proper operation in the programmed frequency band.

#### 4. Data Rate Command

bit	15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0	POR
	1	1	0	0	1	0	0	0	r7	rб	r5	r4	r3	r2	r1	r0	C800h

The transmitted bit rate is determined by the 8-bit value R (bits <*r7 : r0*>) as:

BR = 10 MHz / 29 / (R+1)

Apart from setting custom values, the standard bit rates from 2.4 to 115.2 kbps can be approximated with minimal error.

Note:

• PLL bandwidth should be set according the data rate. Please see the PLL Setting Command.



#### 5. Power Setting Command

			-						
bit	7	6	5	4	3	2	1	0	POR
	1	0	1	1	0	p2	р1	p0	B0h

2	p1	p0	Output Power [dB]
0	0	0	0
0	0	1	-3
0	1	0	-6
0	1	1	-9
1	0	0	-12
1	0	1	-15
1	1	0	-18
1	1	1	-21

The output power is given in the table as relative to the maximum available power, which depends on the actual antenna impedance.

#### 6. Low Battery Detector and TX Bit Synchronization Command

bit	15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0	POR
	1	1	0	0	0	0	1	0	dwc	0	ebs	t4	t3	t2	t1	t0	C200h

Bit 7 <dwc> Disables the Wake-up timer periodical (every 30 second) calibration if this bit is set. Bit 5 <ebs> Enables the TX bit synchronization circuit. The data rate must be set by the Data Rate Command.5

PI commands	Bet the DR ebs=1	ea=1			(Pu+or)	
nIRQ	nIRQ		Bittime			of niRQ
FSK or SDI		TX bi	1 TX bit2	TX bitN		
TX Data			TX bit1	TX bitN-1	TX bin	

The 5-bit value T of <t4 : t0> determines the threshold voltage V  $_{\rm lb}$  of the detector:

#### 7. Sleep Command

bit	15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0	POR
	1	1	0	0	0	1	0	0	s7	s6	s5	s4	s3	s2	s1	s0	C400h

The effect of this command depends on the Power Management Command. It immediately disables the power amplifier (if a0=1 and ea=0) and the synthesizer (if a1=1 and es=0). Stops the crystal oscillator



after S periods of the microcontroller clock (if a1=1 and ex=0) to enable the microcontroller to execute all necessary commands before entering sleep mode itself. The 8-bit value S is determined by bits <s7:s0>.

#### 8. Wake-Up Timer Command

bit	15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0	POR
	1	1	1	r4	r3	r2	r1	r0	m7	m6	m5	m4	m3	m2	m1	m0	E000h

The wake-up time period can be calculated as:

 $T_{wake-up} = M * 2^{R} [ms],$ 

where M is defined by the <m7 : m0> digital value and R is defined by the <r4 : r0> digital value.

#### Note:

• For continual operation the et bit should be cleared and set at the end of every cycle.

#### 9. Data Transmit Command

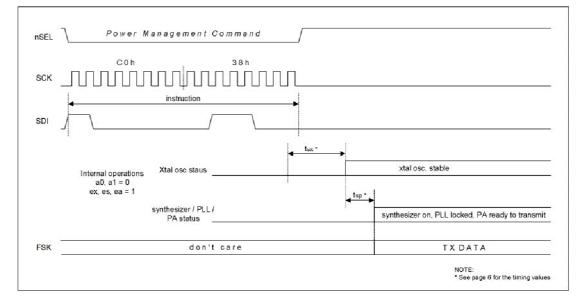
bit	7	6	5	4	3	2	1	0
	1	1	0	0	0	1	1	0

This Command Indicates that the following bitstream coming in via the serial interface is to be transmitted.

#### Note

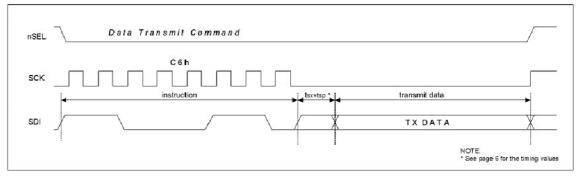
- This command is not needed if the transmitters' power management bits (*ex, es and ea*) are fully controlled by the microcontroller and TX data comes through the FSK pin.
- If the crystal oscillator was formerly switched off (ex=0), the internal oscillator needs  $t_{sx}$  time, to switch on. The actual value depends on the type of quartz crystal used.
- If the synthesizer was formerly switched off (es=0), the internal PLL needs  $t_{sp}$  startup time. Valid data can be transmitted only when the internal locking process is finished.

#### Data Transmit Sequence Through the FSK Pin





Data Transmit Sequence Through the SDI Pin



Note:

Do not send CLK pulses with the TX data bits, otherwise they will be interpreted as commands.

This mode is not SPI compatible.

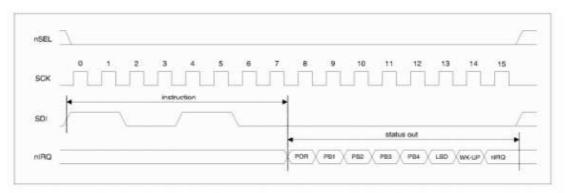
If the crystal oscillator and the PLL are running, the  $t_{sx}$ + $t_{sp}$  delay is not needed.

10.	Status	Register	Read	Command
	olulus	Register	ncuu	oominana

		- J															
bit	15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0	POR
	1	1	0	0	1	1	0	0	0	0	0	0	0	0	0	0	

With this command, it is possible to read the chip's status register through the nIRQ pin. This command clears the last serviced interrupt and processing the next pending one will start (if there is any).

#### **Status Register Read Sequence**



#### 11. PLL Setting Command

PLL command	Max data rate [kbps]	Phase noise at 1MHz offset [dbc/Hz]	Comments
D240h	19.2	-112	25%current
D2C0h	38.4	-110	33%current
D200h	68.9	-107	50%current
D280h	115.2	-102	100%current



## **RX-TX ALIGNMENT PROCEDURES**

RX-TX frequency offset can be caused only by the differences in the actual reference frequency. To minimize these errors it is suggested to use the same crystal type and the same PCB layout for the crystal placement on the RX and TX PCBs.

To verify the possible RX-TX offset it is suggested to measure the CLK output of both chips with a high level of accuracy. Do not measure the output at the XTL pin since the measurement process itself will change the reference frequency. Since the carrier frequencies are derived from the reference frequency, having identical reference frequencies and nominal frequency settings at the TX and RX side there should be no offset if the CLK signals have identical frequencies.

It is possible to monitor the actual RX-TX offset using the AFC status report included in the status byte of the receiver. By reading out the status byte from the receiver the actual measured offset frequency will be reported. In order to get accurate values the AFC has to be disabled during the read by clearing the "en" bit in the AFC Control Command (bit 0).

## **CRYSTAL SELECTION GUIDELINES**

The crystal oscillator of the RFM02 requires a 10 MHz parallel mode crystal. The circuit contains an integrated load capacitor in order to minimize the external component count. The internal load capacitance value is programmable from 8.5 pF to 16 pF in 0.5 pF steps. With appropriate PCB layout, the total load capacitance value can be 10 pF to 20 pF so a variety of crystal types can be used.

When the total load capacitance is not more than 20 pF and a worst case 7 pF shunt capacitance (C0) value is expected for the crystal, the oscillator is able to start up with any crystal having less than 100 ohms ESR (equivalent series loss resistance). However, lower C0 and ESR values guarantee faster oscillator startup. It is recommended to keep the PCB parasitic capacitances on the XTL pin as low as possible.

The crystal frequency is used as the reference of the PLL, which generates the RF carrier frequency (fc). Therefore fc is directly proportional to the crystal frequency. The accuracy requirements for production tolerance, temperature drift and aging can thus be determined from the maximum allowable carrier frequency error.



### Maximum XTAL Tolerances Including Temperature and Aging [ppm]

Bit Rate:	2.4kbps	Transmitter Deviation [+/- kHz]									
		30	60	90	120	150	180	210			
	315 MHz	30	75	100	100	100	100	100			
	433 MHz	20	50	75	100	100	100	100			
	868 MHz	10	25	40	60	75	100	100			
	915 MHz	10	25	40	50	75	75	100			
Bit Rate:	9.6kbps	Transmitter Deviation [+/- kHz]									
		30	60	90	120	150	180	210			
	315 MHz	25	70	100	100	100	100	100			
	433 MHz	15	50	75	100	100	100	100			
	868 MHz	8	25	40	60	75	75	100			
	915 MHz	8	25	40	50	70	75	100			
-											
Bit Rate:	38.3kbps			Transmi	tter Deviation	+/- kHz]					
		30	60	90	120	150	180	210			
	315 MHz	don't use	30	75	100	100	100	100			
	433 MHz	don't use	20	50	75	100	100	100			
	868 MHz	don't use	10	30	40	60	75	100			
	915 MHz	don't use	10	25	40	60	75	75			

Whenever a low frequency error is essential for the application, it is possible to "pull" the crystal to the accurate frequency by changing the load capacitor value. The widest pulling range can be achieved if the nominal required load capacitance of the crystal is in the "midrange", for example 16 pF. The "pull-ability" of the crystal is defined by its motional capacitance and  $C_0$ 

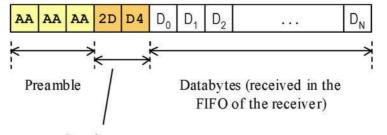
#### Note:

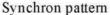
• There may be other requirements for the TX carrier accuracy with regards to the requirements as defined by standards and/or channel separations.

## **EXAMPLE APPLICATIONS: DATA PACKET TRANSMISSION**

#### Data packet structure

An example data packet structure using the RFM02X - RF01 pair for data transmission. This packet structure is an example of how to use the high efficiency FIFO mode at the receiver side:





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The first 3 bytes compose a 24 bit length '01' pattern to let enough time for the clock recovery of the receiver to lock. The next two bytes compose a 16 bit synchron pattern which is essential for the receiver's FIFO to find the byte synchron in the received bit stream. The synchron patters is followed by the payload. The first byte transmitted after the synchron pattern (D0 in the picture above) will be the first received byte in the FIFO.

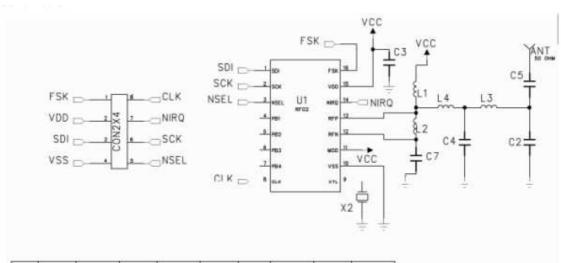
Important: The bytes of the data stream should follow each other continuously, otherwise the clock recovery circuit of the receiver side will be unable to track.

Further details of packet structures can be found in the RF ISM-UGSB1 software development kit manual



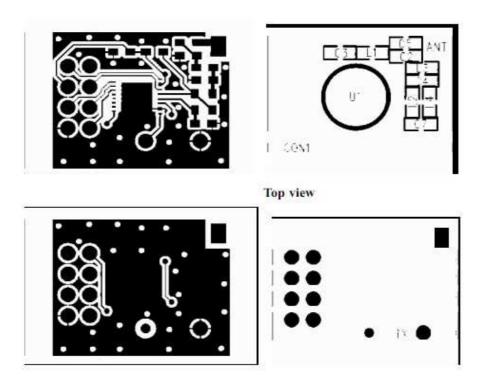
# **REFERENCE DESIGNS**

### Schematic



	C3	L1	L2	C7	L4	C4	L3	C2	C5
434	10nF	220nH	27nH	4.7PF	22nH	10PF	27nH	12PF	5.6PF
869	10nF	47nH	10nH	3.3PF	8.2nH	3.9PF	15nH	3.9PF	5.6PF
915	10nF	47nH	10nH	3.3PF	8.2nH	3.3PF	15nH	3.9PF	5.6PF

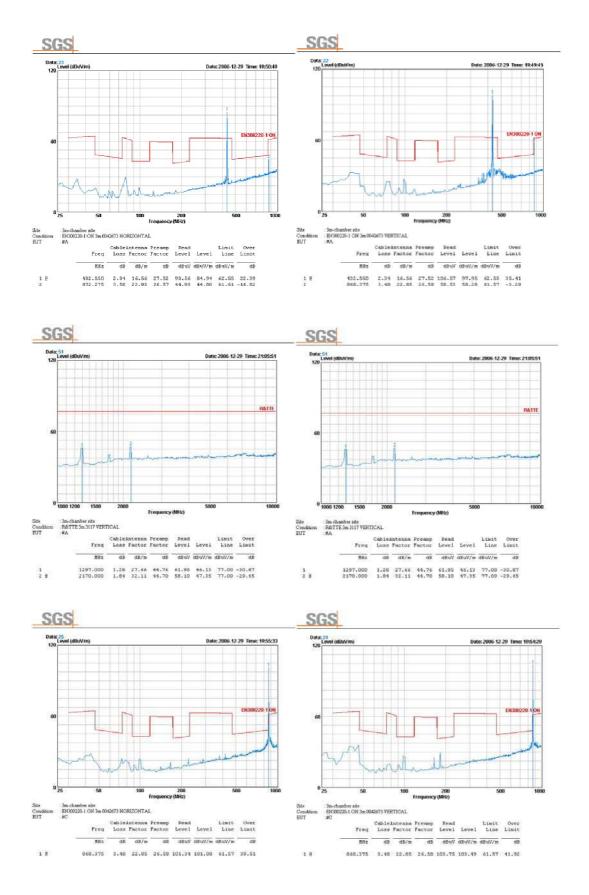
PCB layout



**Bottom view** 



# **SGS Reports**

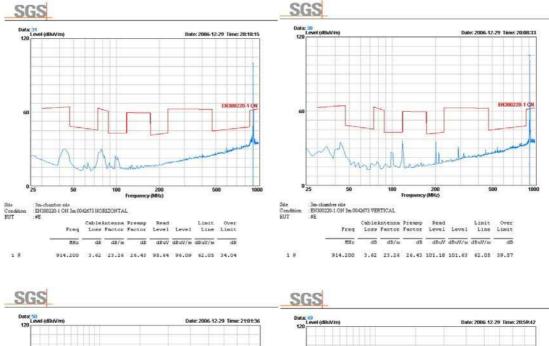


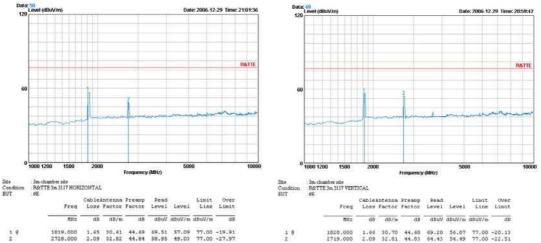






		Freq			Factor			Line	
		MHz	dīt	dD/m	dħ	dBuV	dBuV/m	dBuV/m	dB
1 2 3		1720.000			44.70				
-2	8	2602.000	2,04	32.54	44.80	70,10	67.91	77.00	-9.09
.3		3465.000	2.35	33.21	45.01	56.47	47.02	77.00	-25.98

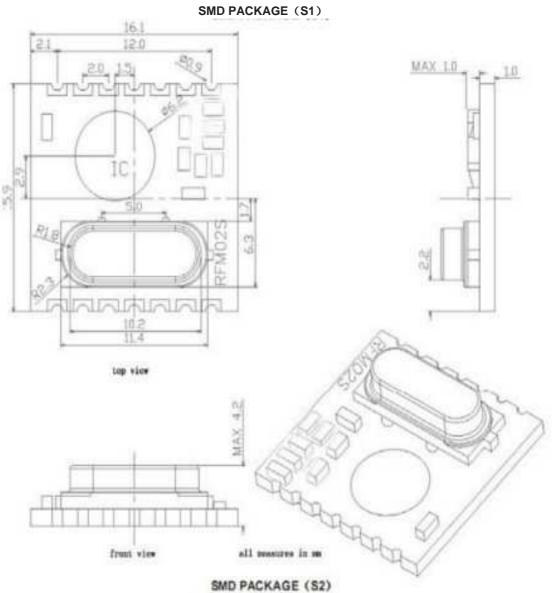




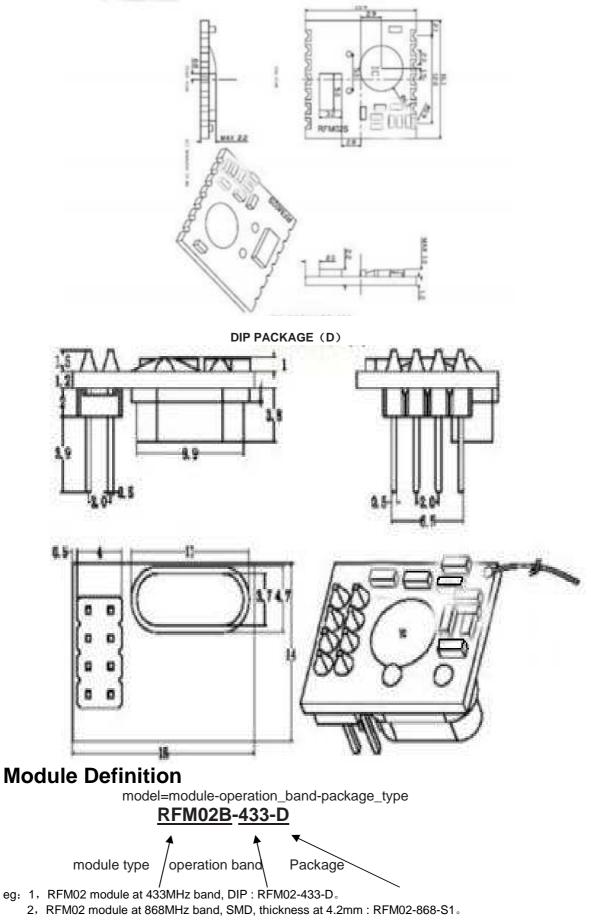


# **Mechanical Dimension:**













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